

# SGM9132 3-Channel, Video Filter Driver for HD (1080p)

### **PRODUCT DESCRIPTION**

The SGM9132 video filter is intended to replace passive LC filters and drivers with an integrated device. Three 6th-order channels offer High Definition (HDp) filters. The SGM9132 may be directly driven by a DC-coupled DAC output or an AC-coupled signal. Internal bias circuitry provides constant bias voltage for AC-coupled inputs.

The outputs can be AC- or DC-coupled. DC coupling the outputs removes the need for large output coupling capacitors.

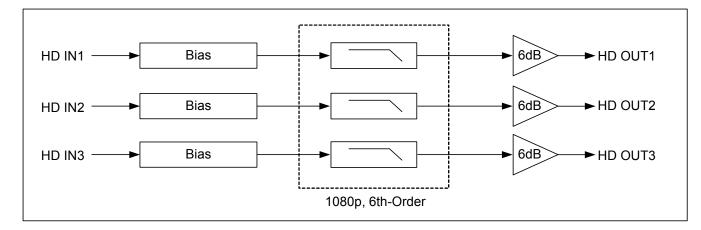
The SGM9132 is available in Green SOIC-8 (Exposed Pad) package. It operates over an ambient temperature range of  $-40^{\circ}$ C to  $+85^{\circ}$ C.

#### FEATURES

- Three 6th-Order Filters for 1080p High Definition Mode
- Bias Mode Active with AC-Coupled Inputs
- Bias Mode Inactive with DC-Coupled Inputs
- AC- or DC-Coupled Outputs
- DC-Coupled Output Eliminates AC Coupling Capacitor
- Available in Green SOIC-8 (Exposed Pad) Package
- -40°C to +85°C Operating Temperature Range

## APPLICATIONS

Set-Top Boxes Communication Devices Portable and Handheld Products Personal Video Recorders Video on Demand DVD Players HDTVs



## **BLOCK DIAGRAM**



### 3-Channel, Video Filter Driver for HD (1080p)

### PACKAGE/ORDERING INFORMATION

ORDER NUMBER	PACKAGE	TEMPERATURE	MARKING	PACKAGE
	DESCRIPTION	RANGE	INFORMATION	OPTION
SGM9132YPS8G/TR	SOIC-8 (Exposed Pad)	-40°C to +85°C	SGM9132YPS8	Tape and Reel, 2500

### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, GND to V <sub>CC</sub>	6V
Input Voltage	. GND - 0.3V to V <sub>CC</sub> + 0.3V
Storage Temperature Range	65°C to +150°C
Junction Temperature	150°C
Operating Temperature Range	40°C to +85°C
Lead Temperature Range (Soldering	g 10 sec)
	260°C
ESD Susceptibility	

НВМ	8000V
MM	400V

#### NOTE:

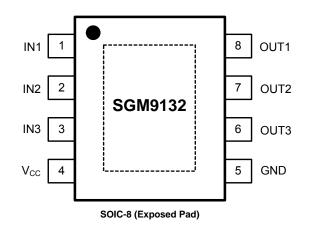
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the latest datasheet.

# PIN CONFIGURATION (TOP VIEW)



## **PIN DESCRIPTION**

PIN	NAME	FUNCTION
1	IN1	Video Input. Channel 1.
2	IN2	Video Input. Channel 2.
3	IN3	Video Input. Channel 3.
4	V <sub>CC</sub>	Power Supply.
5	GND	Ground.
6	OUT3	Video Output. Channel 3.
7	OUT2	Video Output. Channel 2.
8	OUT1	Video Output. Channel 1.
Exposed Paddle	_	Exposed Paddle. Can only be connected to GND or left floating.



## 3-Channel, Video Filter Driver for HD (1080p)

# **ELECTRICAL CHARACTERISTICS**

 $(T_A = +25^{\circ}C, V_{IN} = 1V_{PP}, V_{CC} = 5V, R_{SOURCE} = 37.5\Omega$ ; all inputs are AC-coupled with  $0.1\mu$ F; all outputs are AC-coupled with  $220\mu$ F into 150 $\Omega$ , referenced to 400kHz, unless otherwise noted.)

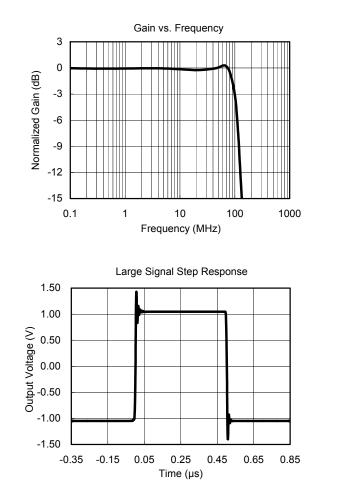
PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS	
DC ELECTRICAL CHARACTERISTICS						
Operating Voltage Range (V <sub>CC</sub> )		3.1	5	5.5	V	
Quiescent Current (I <sub>Q</sub> )	V <sub>CC</sub> = 5V, No load		76	97	mA	
Output Level Shift Voltage (Vols)	$V_{IN} = 0V$ , No load		500	660	mV	
Voltage Gain (A <sub>V</sub> )	R <sub>L</sub> = 150Ω 5.8		6.1	6.35	dB	
Output Voltage High Swing	$V_{IN}$ = 3V, $R_L$ = 150 $\Omega$ to GND	$_{\rm IN}$ = 3V, R <sub>L</sub> = 150 $\Omega$ to GND			V	
Video Input Voltage Range	Referenced to GND if DC-coupled		1.4		V <sub>PP</sub>	
Power Supply Rejection Ratio (PSRR)	io (PSRR) DC (All channels)		50		dB	
1080p HIGH DEFINITION MODE ELEC	TRICAL CHARACTERISTICS					
-0.1dB Bandwidth	R <sub>L</sub> = 150Ω		78		MHz	
-1dB Bandwidth	Bandwidth $R_L = 150\Omega$		86		MHz	
-3dB Bandwidth	width $R_L = 150\Omega$		98		MHz	
Filter Response (Normalized Gain)	Iter Response (Normalized Gain) f <sub>IN</sub> = 400kHz to 148MHz		21		dB	
Slew Rate	ate 2V Output step, 80% to 20%		340		V/µs	
Group Delay Variation (D/DT)	D/DT) Difference between 400kHz and 70MHz		7		ns	
Crosstalk (channel-to-channel)	V <sub>OUT</sub> = 1.4V <sub>PP</sub> , f = 1MHz -65		-65		dB	
Fall Time	2V Output step, 80% to 20%	Dutput step, 80% to 20% 3.3			ns	
Rise Time	2V Output step, 80% to 20%		3.6		ns	

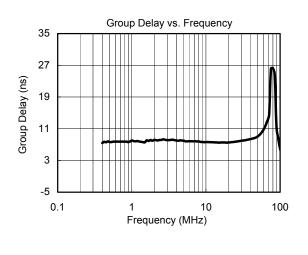


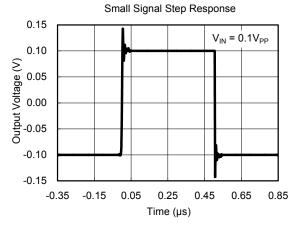
## 3-Channel, Video Filter Driver for HD (1080p)

## **TYPICAL PERFORMANCE CHARACTERISTICS**

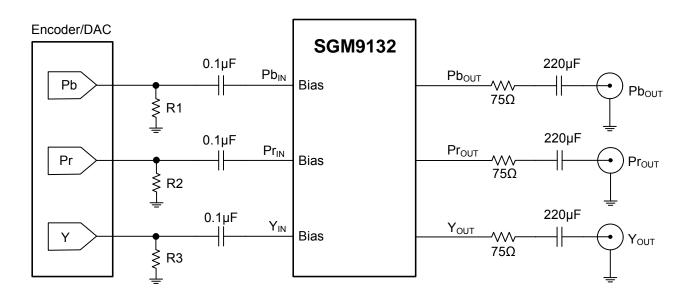
 $T_A = +25^{\circ}$ C,  $V_{IN} = 1V_{PP}$ ,  $V_{CC} = 5$ V,  $R_{SOURCE} = 37.5\Omega$ ; all inputs are AC-coupled with  $0.1\mu$ F; all outputs are AC-coupled with  $220\mu$ F into 150 $\Omega$ , referenced to 400kHz, unless otherwise noted.







# **TYPICAL APPLICATION CIRCUIT**





## **APPLICATION INFORMATION**

#### **Application Circuits**

The SGM9132 video filter provides 6dB gain from input to output. In addition, the input is slightly offset to optimize the output driver performance. The offset is held to the minimum required value to decrease the standing DC current into the load.

For symmetric signals like Chroma, U, V, Pb and Pr, the average DC bias is fairly constant and the inputs can be AC-coupled. DAC outputs can also drive these same signals without the AC coupling capacitor.

#### **I/O Configurations**

For an AC-coupled DAC drive with AC-coupled outputs, use the configuration in Figure 1.

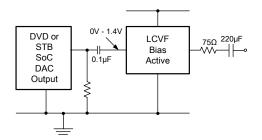


Figure 1. AC-Coupled Inputs and Outputs

Alternatively, if the DAC's average DC output level causes the signal to exceed the range from 0V to 1.4V, it can be AC-coupled as shown in Figure 2.

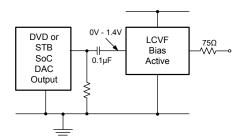


Figure 2. AC-Coupled Inputs, DC-Coupled Outputs

For a DC-coupled DAC drive with DC-coupled outputs, use the configuration in Figure 3.

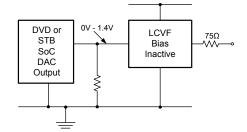


Figure 3. DC-Coupled Inputs and Outputs

NOTE: The video tilt or line time distortion is dominated by the AC coupling capacitor. The value may need to be increased beyond  $220\mu$ F to obtain satisfactory operation in some applications.

#### **Power Dissipation**

The SGM9132 output drive configuration must be considered when calculating overall power dissipation. Care must be taken not to exceed the maximum die junction temperature. The following equations can be used to calculate the power dissipation and internal temperature rise.

$T_{J} = T_{A} + P_{D} \cdot \theta_{JA}$	(1)
where:	
$P_{D} = P_{CH1} + P_{CH2} + P_{CH3}$	(2)
$P_{CHX} = V_{CC} \cdot I_{CH} - (V_0^2/R_L)$	(3)
where:	
$V_{\rm O} = 2V_{\rm IN} + 0.5V$	(4)
$I_{CH} = (I_{CC}/3) + (V_0/R_L)$	(5)
V <sub>IN</sub> = RMS value of input signal	
I <sub>CC</sub> = 76mA	
$V_{CC} = 5.0V$	
R <sub>L</sub> = channel load resistance	

Board layout can also affect thermal characteristics. Refer to the Layout Considerations section for details.

The SGM9132 is specified to operate with output currents typically less than 50mA, more than sufficient for a dual (75 $\Omega$ ) video load. Internal amplifiers are current limited to a maximum of 100mA and should withstand brief-duration short-circuit conditions. This capability is not guaranteed.



## **APPLICATION INFORMATION**

#### **Output Considerations**

The selection of the coupling capacitor is a function of the subsequent circuit input impedance and the leakage current of the input being driven. In order to obtain the highest quality output video signal the series termination resistor must be placed as close to the device output pin as possible. This greatly reduces the parasitic capacitance and inductance effect on the SGM9132 output driver. Recommended distance from device pin to series termination resistor should be no greater than 0.1 inches.

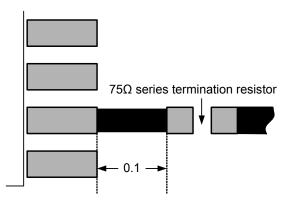


Figure 4. Distance from Device Pin to Series Termination Resistor

#### **Thermal Considerations**

Since the interior of systems such as set-top boxes, TVs and DVD players are at +70°C, consideration must be given to providing an adequate heat sink for the device package for maximum heat dissipation. When designing a system board, determine how much power each device dissipates. Ensure that devices of high power are not placed in the same location, such as directly above (top plane) or below (bottom plane) each other on the PCB.

#### Layout Considerations

General layout and supply bypassing play a major role in high-frequency performance and thermal characteristics. We offer a demonstration board to guide layout and aid device evaluation. The demo board is a four-layer board with full power and ground planes. Following this layout configuration provides optimum performance and thermal characteristics for the device. For the best results, follow the steps and recommended routing rules listed below.

#### **Recommended Routing/Layout Rules**

• Do not run analog and digital signals in parallel.

• Use separate analog and digital power planes to supply power.

- Do not run traces on top of the ground plane.
- Run no traces over ground/power splits.
- Avoid routing at 90-degree angles.
- Minimize clock and video data trace length differences.
- Include 0.01 $\mu F$  and 0.1 $\mu F$  ceramic power supply bypass capacitors.
- Place the  $0.1 \mu F$  capacitor within 0.1 inches of the device power pin.
- Place the  $0.01 \mu F$  capacitor within 0.75 inches of the device power pin.

• For multi-layer boards, use a large ground plane to help dissipate heat.

• For two-layer boards, use a ground plane that extends beyond the device body at least 0.5 inches on all sides. Include a metal paddle under the device on the top layer.

• Minimize all trace lengths to reduce series inductance.

• Place a  $75\Omega$  series resistor within 0.5 inches of the output pin to isolate the output driver from board parasitics.

#### **PCB Thermal Layout Considerations**

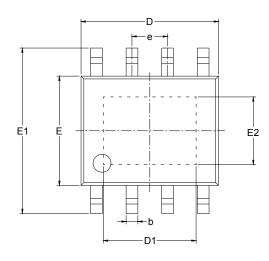
• Understand the system power requirements and environmental conditions.

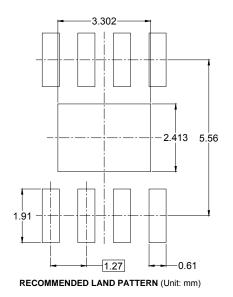
- Maximize thermal performance of the PCB.
- Consider using 70µm of copper for high-power designs.
- Make the PCB as thin as possible by reducing FR4 thickness.
- Use vias in the power pad to tie adjacent layers together.
- Remember that baseline temperature is a function of board area, not copper thickness.
- Consider modeling techniques a first-order approximation.

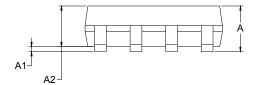


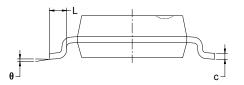
# PACKAGE OUTLINE DIMENSIONS

## SOIC-8 (Exposed Pad)









Symbol	Dimensions In Millimeters		Dimensions In Inches		
	MIN	MAX	MIN	МАХ	
A		1.700		0.067	
A1	0.000	0.100	0.000	0.004	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.007	0.010	
D	4.700	5.100	0.185	0.201	
D1	3.202	3.402	0.126	0.134	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
E2	2.313	2.513	0.091	0.099	
е	1.27 BSC		0.050	BSC	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

